

Advanced Power MOSFET

SSF7N60A

FEATURES

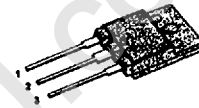
- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- Extended Safe Operating Area
- Lower Leakage Current : 25 μ A (Max.) @ $V_{DS} = 600V$
- Lower $R_{DS(on)}$: 0.977 Ω (Typ.)

$$BV_{DSS} = 600 V$$

$$R_{DS(on)} = 1.2 \Omega$$

$$I_D = 5.4 A$$

TO-3PF



1. Gate 2. Drain 3. Source

Absolute Maximum Ratings

Symbol	Characteristic	Value	Units
V_{DSS}	Drain-to-Source Voltage	600	V
I_D	Continuous Drain Current ($T_c=25^\circ C$)	5.4	A
	Continuous Drain Current ($T_c=100^\circ C$)	3.4	
I_{DM}	Drain Current-Pulsed ①	30	A
V_{GS}	Gate-to-Source Voltage	± 30	V
E_{AS}	Single Pulsed Avalanche Energy ②	477	mJ
I_{AR}	Avalanche Current ①	5.4	A
E_{AR}	Repetitive Avalanche Energy ③	8.6	mJ
dv/dt	Peak Diode Recovery dv/dt ④	3.0	V/ns
P_D	Total Power Dissipation ($T_c=25^\circ C$)	86	W
	Linear Derating Factor	0.69	
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 to +150	$^\circ C$
T_L	Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5-seconds	300	

Thermal Resistance

Symbol	Characteristic	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	1.45	$^\circ C/W$
$R_{\theta JA}$	Junction-to-Ambient	—	40	



Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
BV_{DSS}	Drain-Source Breakdown Voltage	600	—	—	V	$V_{GS}=0V, I_D=250\mu A$
$\Delta BV/\Delta T_J$	Breakdown Voltage Temp. Coeff.	—	0.65	—	$V/^\circ C$	$I_D=250\mu A$ See Fig 7
$V_{GS(th)}$	Gate Threshold Voltage	2.0	—	4.0	V	$V_{DS}=5V, I_D=250\mu A$
I_{GSS}	Gate-Source Leakage, Forward	—	—	100	nA	$V_{GS}=30V$
	Gate-Source Leakage, Reverse	—	—	-100	nA	$V_{GS}=-30V$
I_{DSS}	Drain-to-Source Leakage Current	—	—	25	μA	$V_{DS}=600V$
		—	—	250		$V_{DS}=480V, T_C=125^\circ C$
$R_{DS(on)}$	Static Drain-Source On-State Resistance	—	—	1.2	Ω	$V_{GS}=10V, I_D=2.7A$ ④
g_{fs}	Forward Transconductance	—	4.74	—	\bar{U}	$V_{DS}=50V, I_D=2.7A$ ④
C_{iss}	Input Capacitance	—	1150	1500	pF	$V_{GS}=0V, V_{DS}=25V, f=1MHz$ See Fig 5
C_{oss}	Output Capacitance	—	130	150		
C_{rss}	Reverse Transfer Capacitance	—	53	62		
$t_{d(on)}$	Turn-On Delay Time	—	18	45	ns	$V_{DD}=300V, I_D=7A,$ $R_G=9.1\Omega$ See Fig 13 ④ ⑤
t_r	Rise Time	—	19	50		
$t_{d(off)}$	Turn-Off Delay Time	—	72	155		
t_f	Fall Time	—	28	65		
Q_g	Total Gate Charge	—	49	65	nC	$V_{DS}=480V, V_{GS}=10V,$ $I_D=7A$ See Fig 6 & Fig 12 ④ ⑤
Q_{gs}	Gate-Source Charge	—	8.4	—		
Q_{gd}	Gate-Drain ("Miller") Charge	—	22.1	—		

Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
I_S	Continuous Source Current	—	—	5.4	A	Integral reverse pn-diode in the MOSFET
I_{SM}	Pulsed-Source Current ①	—	—	30		
V_{SD}	Diode Forward Voltage ④	—	—	1.4	V	$T_J=25^\circ C, I_S=5.4A, V_{GS}=0V$
t_{rr}	Reverse Recovery Time	—	415	—	ns	$T_J=25^\circ C, I_F=7A$
Q_{rr}	Reverse Recovery Charge	—	3.8	—	μC	$di_F/dt=100A/\mu s$ ④

Notes :

- ① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- ② $L=30mH, I_{AS}=5.4A, V_{DD}=50V, R_G=2\Omega$, Starting $T_J=25^\circ C$
- ③ $I_{SD} \leq 7A, di/dt \leq 120A/\mu s, V_{DD} \leq BV_{DSS}$, Starting $T_J=25^\circ C$
- ④ Pulse Test : Pulse Width = $250\mu s$, Duty Cycle $\leq 2\%$
- ⑤ Essentially Independent of Operating Temperature

Fig 1. Output Characteristics

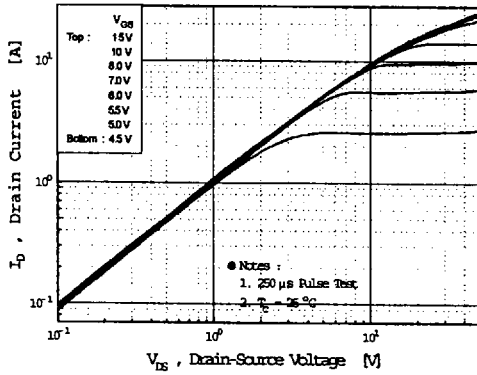


Fig 2. Transfer Characteristics

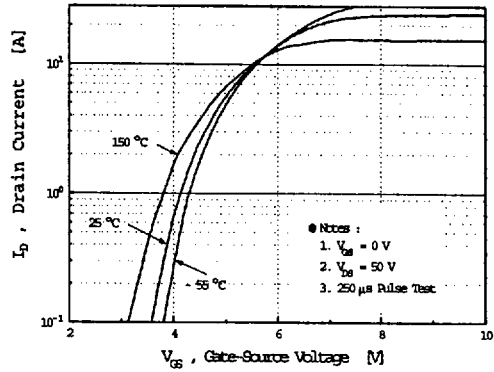


Fig 3. On-Resistance vs. Drain Current

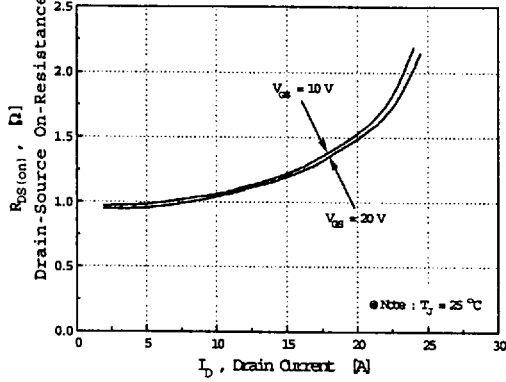


Fig 4. Source-Drain Diode Forward Voltage

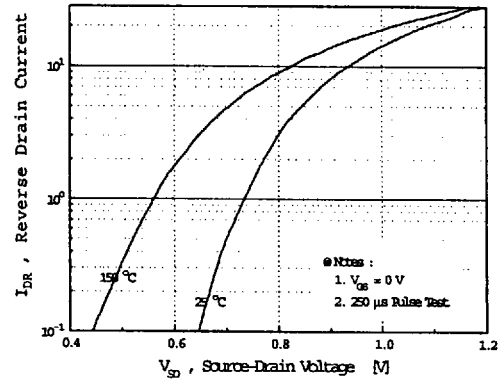


Fig 5. Capacitance vs. Drain-Source Voltage

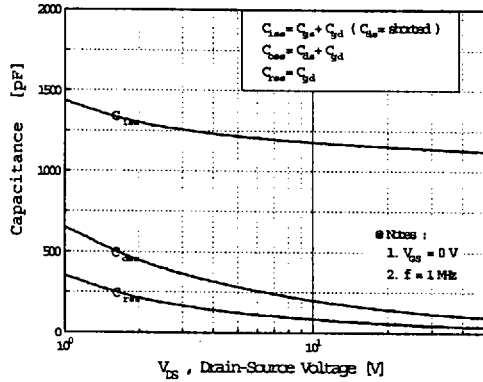
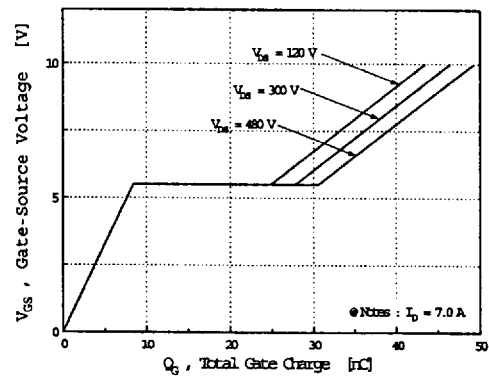
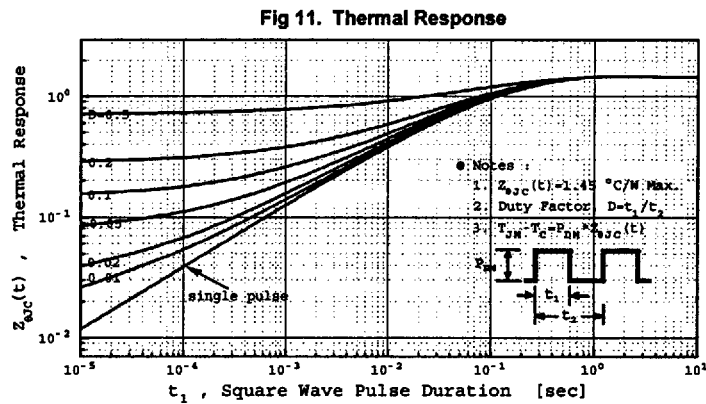
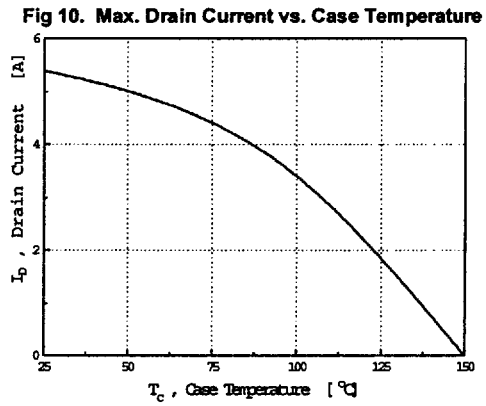
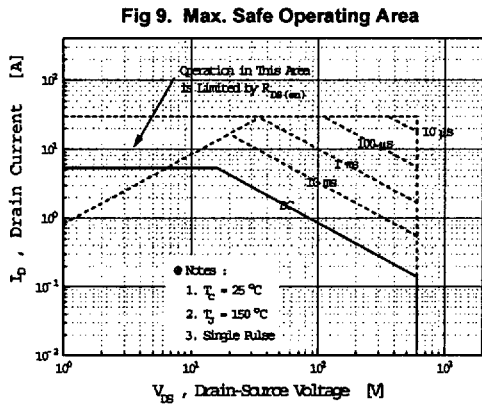
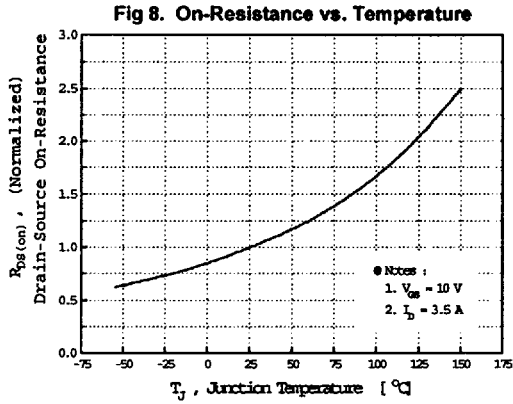
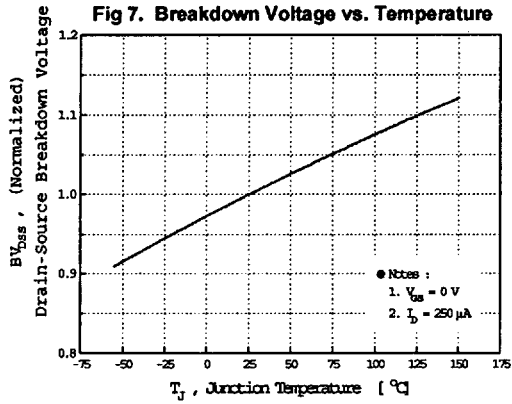


Fig 6. Gate Charge vs. Gate-Source Voltage



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Fig 12. Gate Charge Test Circuit & Waveform

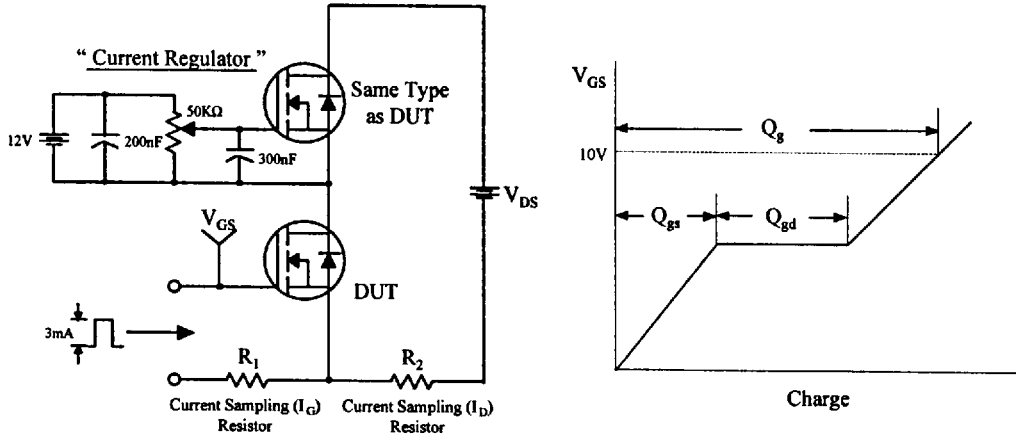


Fig 13. Resistive Switching Test Circuit & Waveforms

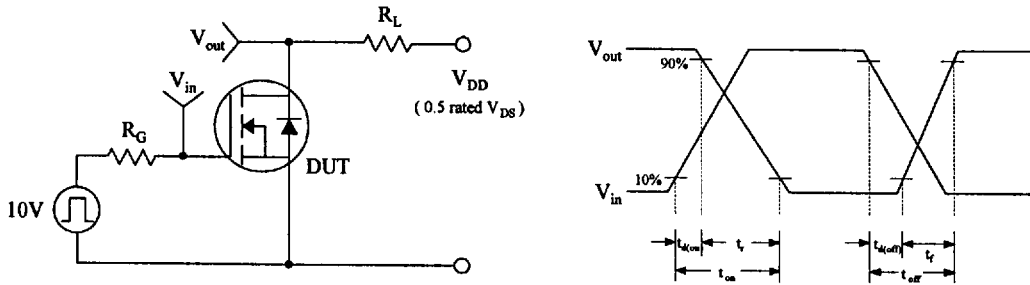
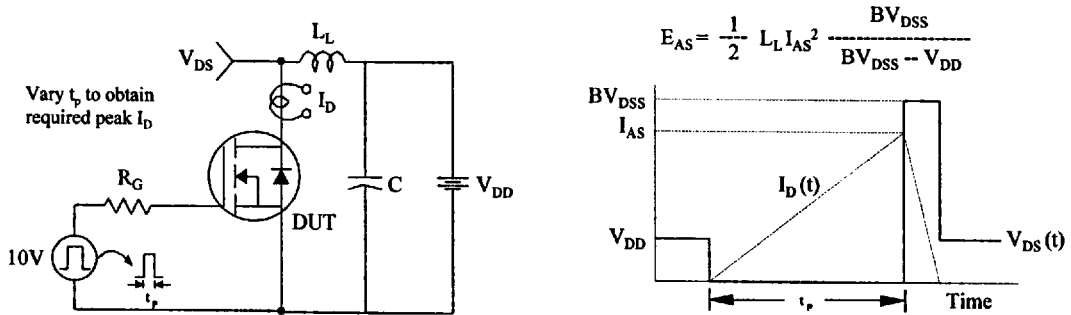
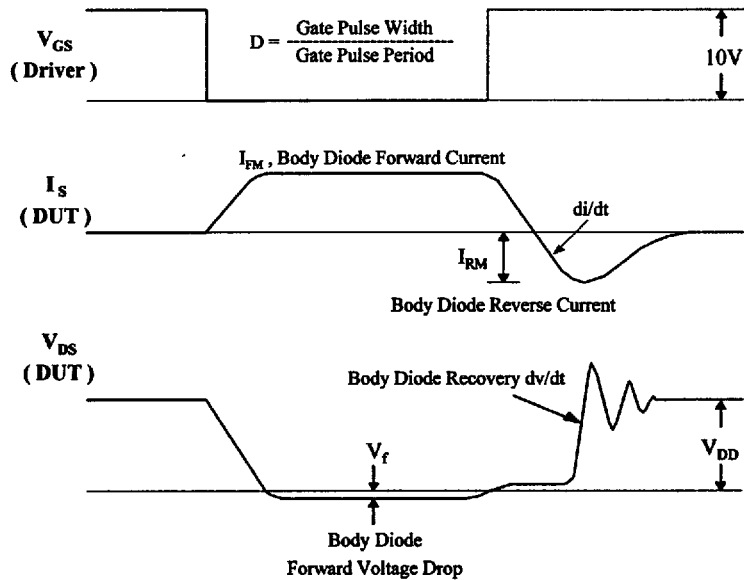
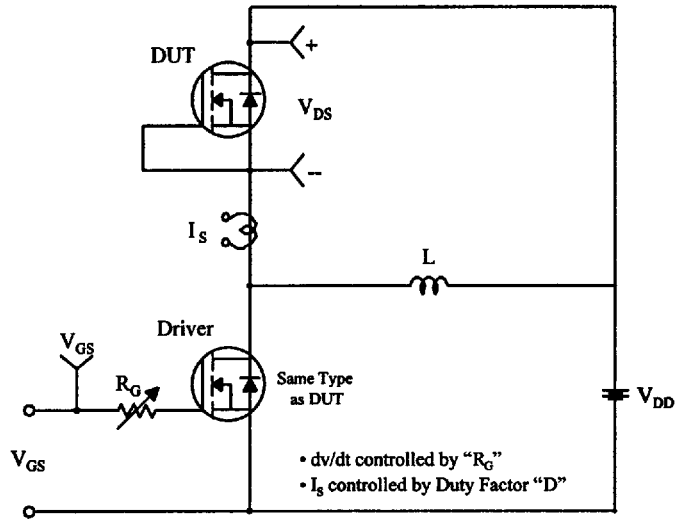


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

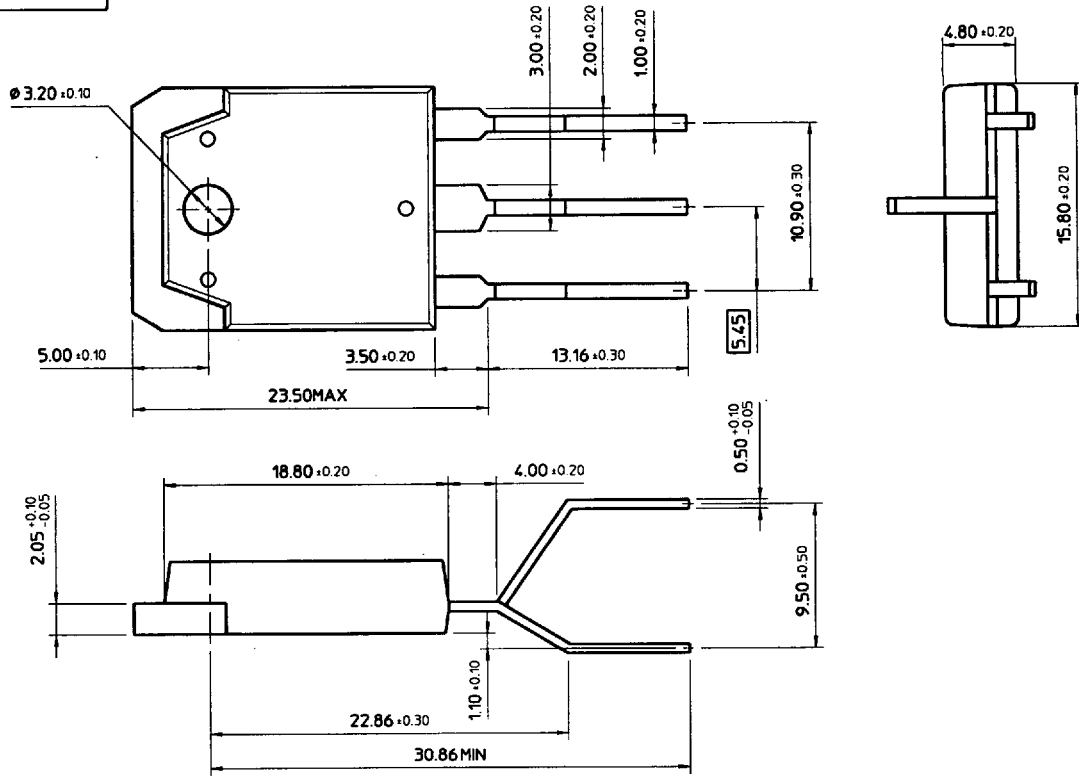


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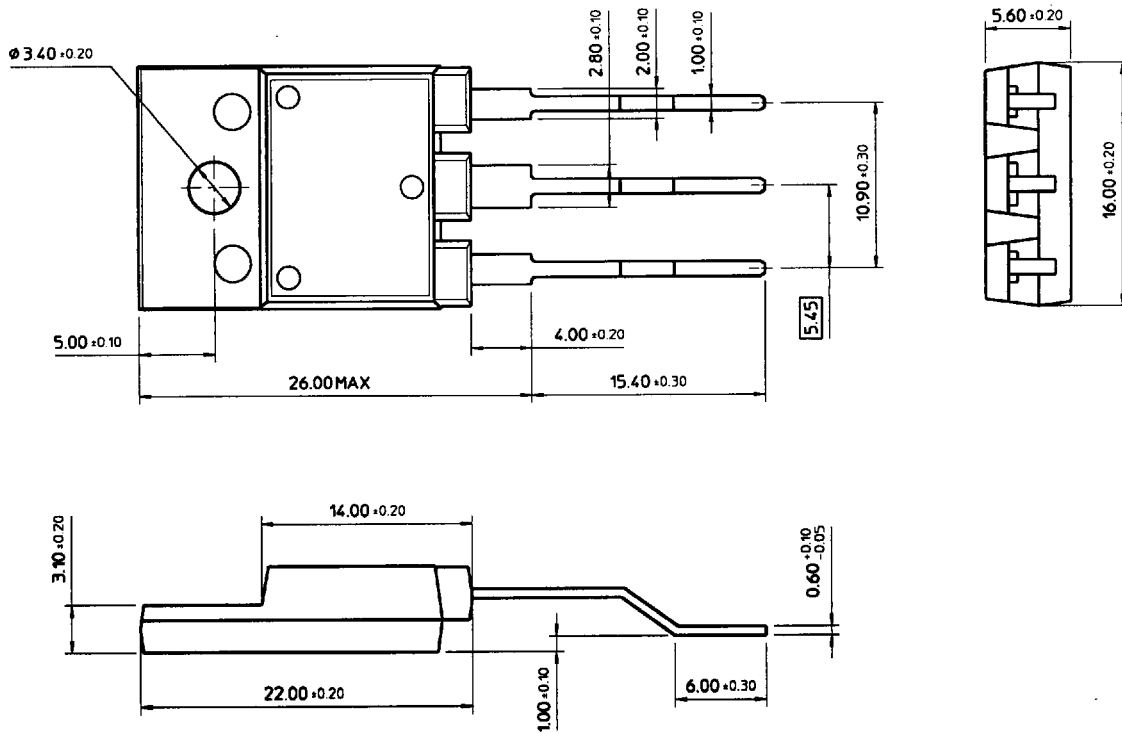
Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



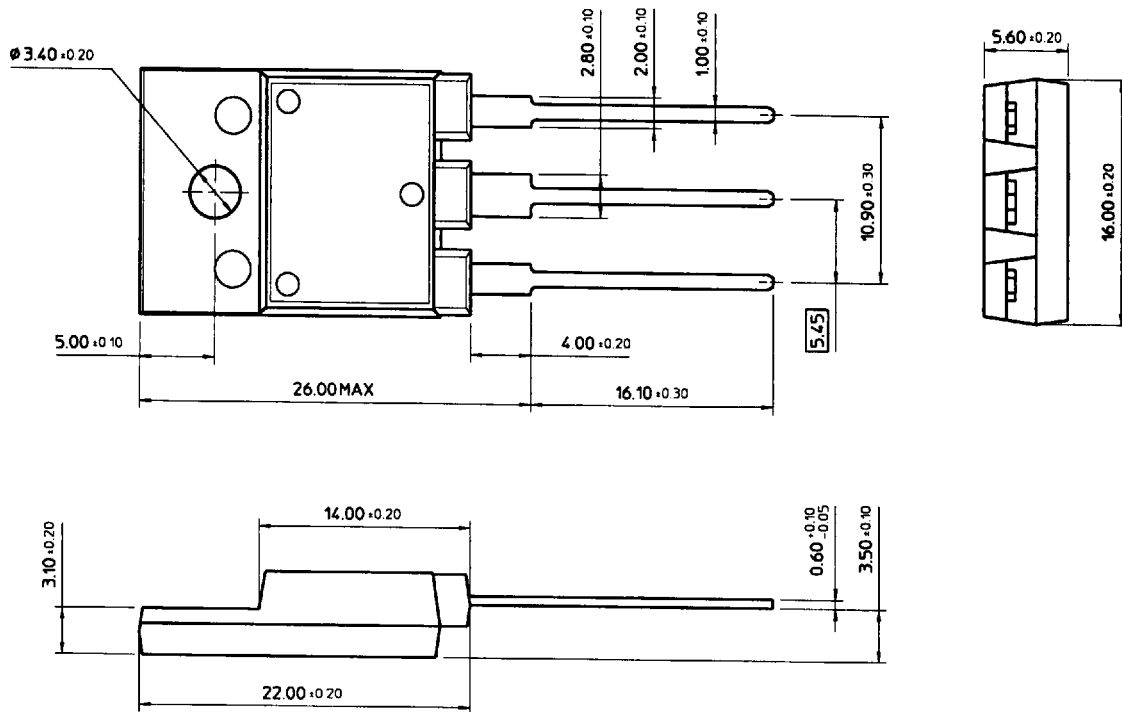
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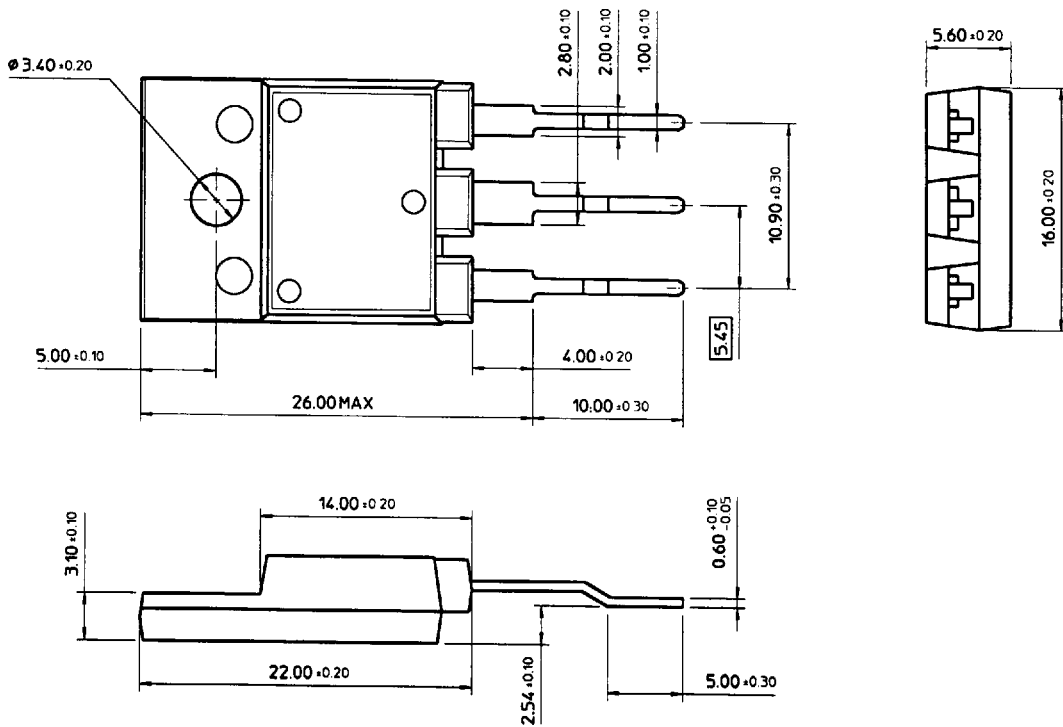
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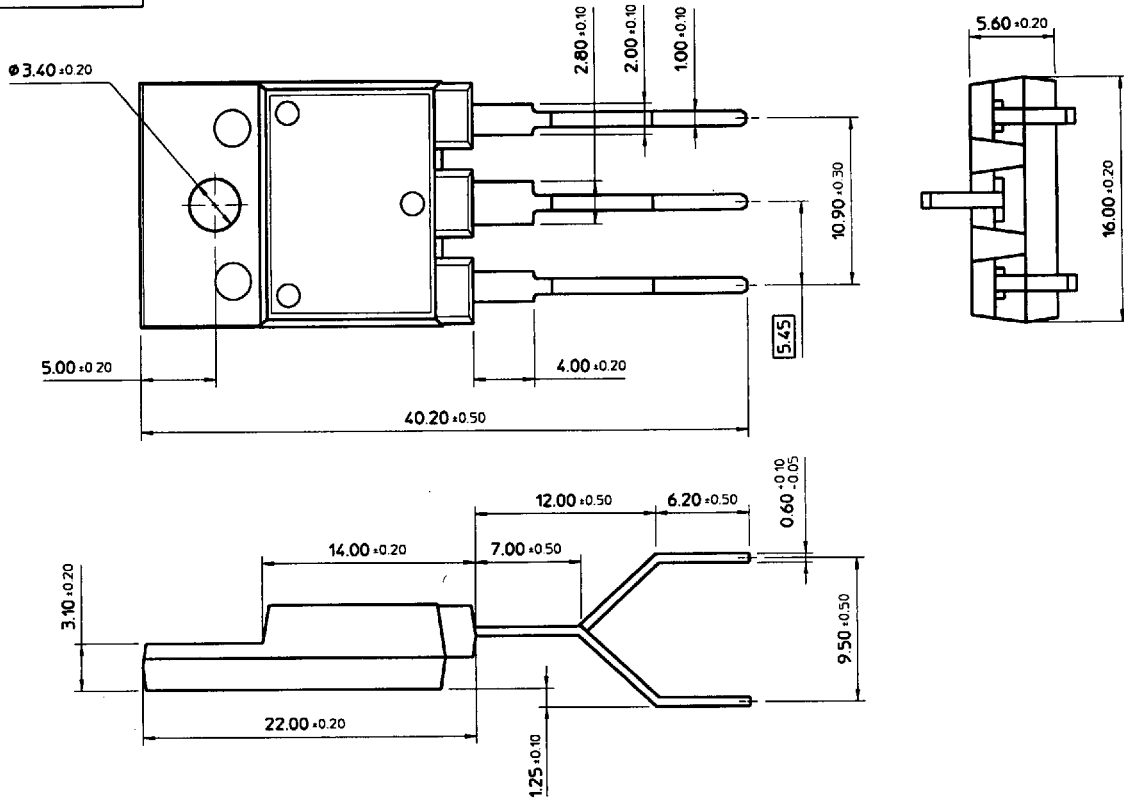
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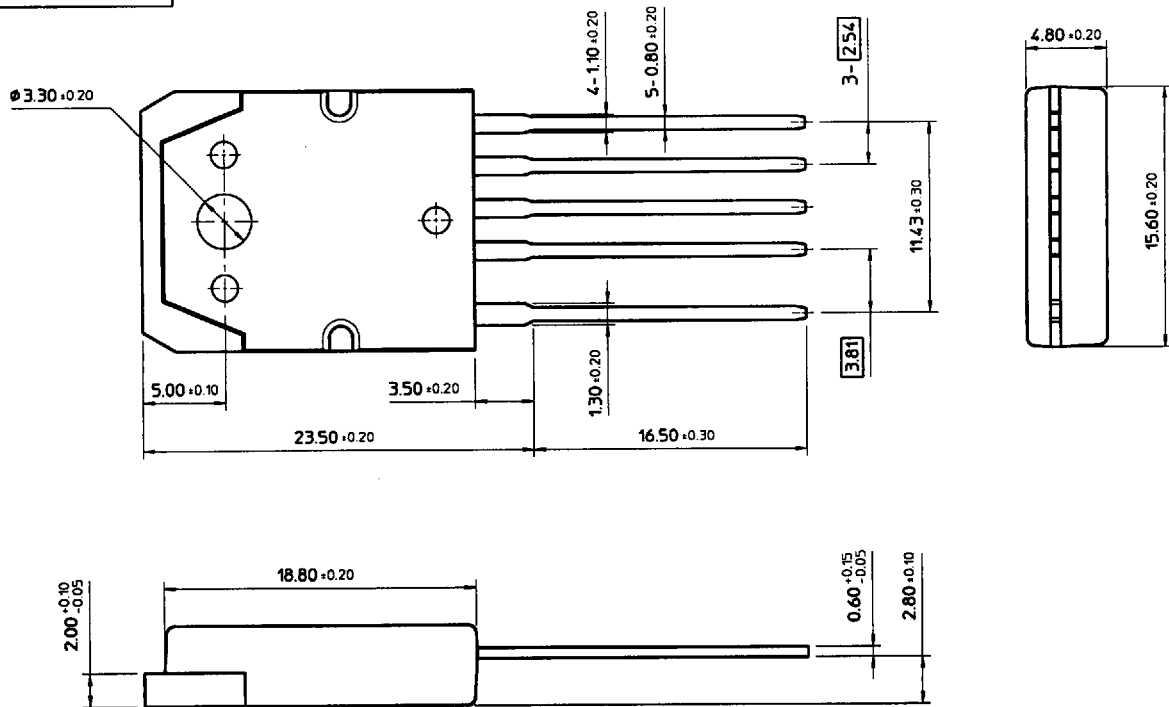
TO-3PF (3)



TO-3PF (4)



TO-3P-5L



Under Development